



SamHop Microelectronics Corp.

STM6914

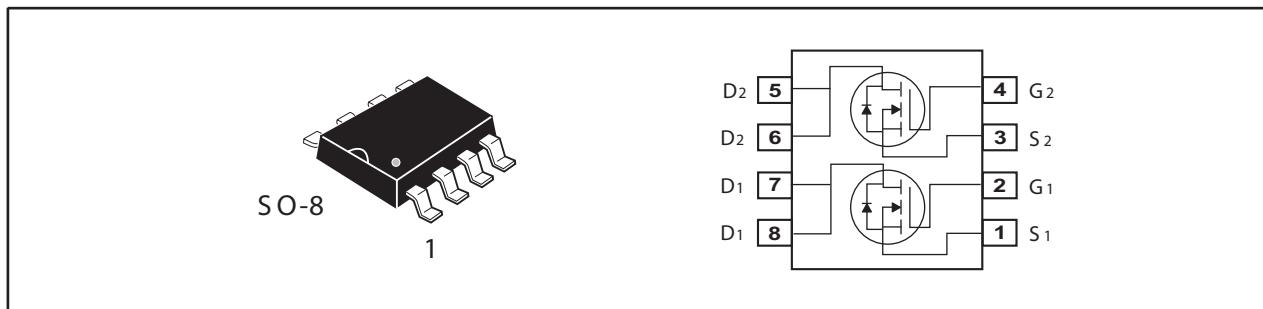
Ver 1.0

Dual N-Channel Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY		
V _{DSS}	I _D	R _{DSON} (mΩ) Max
30V	6.5A	32 @ V _{GS} =10V
		52 @ V _{GS} =4.5V

FEATURES

- Super high dense cell design for low R_{DSON}.
- Rugged and reliable.
- Surface Mount Package.



ABSOLUTE MAXIMUM RATINGS (T_A=25°C unless otherwise noted)

Symbol	Parameter	Limit	Units	
V _{DS}	Drain-Source Voltage	30	V	
V _{GS}	Gate-Source Voltage	±20	V	
I _D	Drain Current-Continuous ^a	T _A =25°C	6.5	A
		T _A =70°C	5.2	A
I _{DM}	-Pulsed ^b	24	A	
P _D	Maximum Power Dissipation ^a	T _A =25°C	2	W
		T _A =70°C	1.28	W
T _J , T _{STG}	Operating Junction and Storage Temperature Range	-55 to 150	°C	

THERMAL CHARACTERISTICS

R _{θ JA}	Thermal Resistance, Junction-to-Ambient ^a	62.5	°C/W
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Details are subject to change without notice.

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ELECTRICAL CHARACTERISTICS (TA=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	30			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =24V , V _{GS} =0V			1	uA
I _{GSS}	Gate-Body Leakage Current	V _{GS} = ±20V , V _{DS} =0V			±100	nA
ON CHARACTERISTICS						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250uA	1	1.9	3	V
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =10V , I _D =6.5A		26	32	m ohm
		V _{GS} =4.5V , I _D =5.1A		40	52	m ohm
g _{FS}	Forward Transconductance	V _{DS} =5V , I _D =6.5A		7		S
DYNAMIC CHARACTERISTICS ^c						
C _{ISS}	Input Capacitance	V _{DS} =15V,V _{GS} =0V f=1.0MHz		513		pF
C _{OSS}	Output Capacitance			91		pF
C _{RSS}	Reverse Transfer Capacitance			73		pF
SWITCHING CHARACTERISTICS ^c						
t _{D(ON)}	Turn-On Delay Time	V _{DD} =15V I _D =1A V _{GS} =10V R _{GEN} =6 ohm		10		ns
t _r	Rise Time			11		ns
t _{D(OFF)}	Turn-Off Delay Time			17.5		ns
t _f	Fall Time			10.5		ns
Q _g	Total Gate Charge	V _{DS} =15V,I _D =6.5A,V _{GS} =10V		9.2		nC
		V _{DS} =15V,I _D =6.5A,V _{GS} =4.5V		4.7		nC
Q _{gs}	Gate-Source Charge	V _{DS} =15V,I _D =6.5A, V _{GS} =4.5V		1.3		nC
Q _{gd}	Gate-Drain Charge			2.7		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
I _s	Maximum Continuous Drain-Source Diode Forward Current			2		A
V _{SD}	Diode Forward Voltage ^b	V _{GS} =0V,I _s =2A		0.82	1.2	V
Notes						
a.Surface Mounted on FR4 Board,t ≤ 10sec.						
b.Pulse Test:Pulse Width ≤ 300us, Duty Cycle ≤ 2%.						
c.Guaranteed by design, not subject to production testing.						

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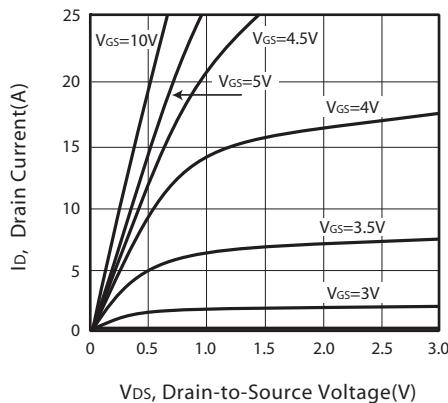


Figure 1. Output Characteristics

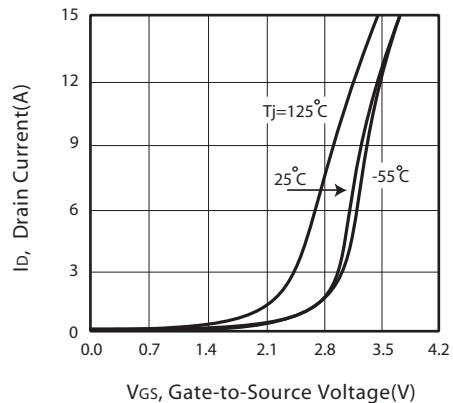


Figure 2. Transfer Characteristics

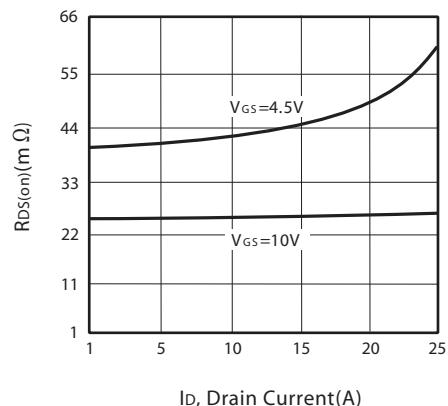


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

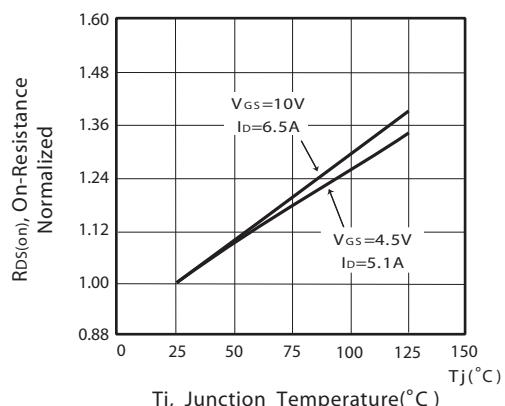


Figure 4. On-Resistance Variation with Drain Current and Temperature

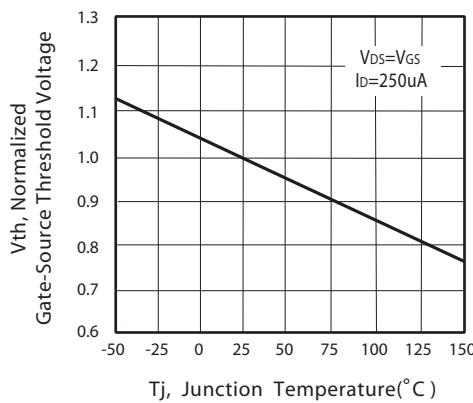


Figure 5. Gate Threshold Variation with Temperature

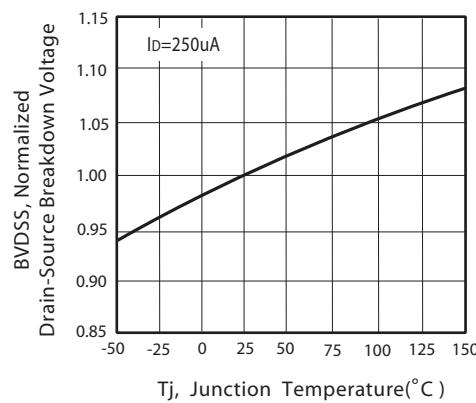
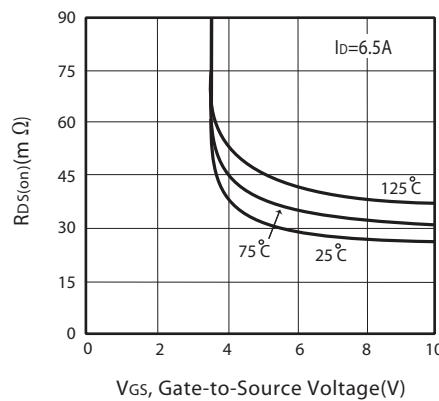


Figure 6. Breakdown Voltage Variation with Temperature

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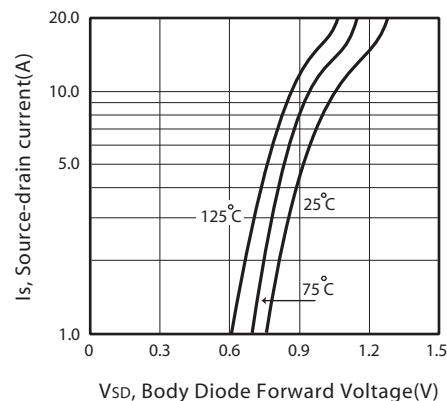
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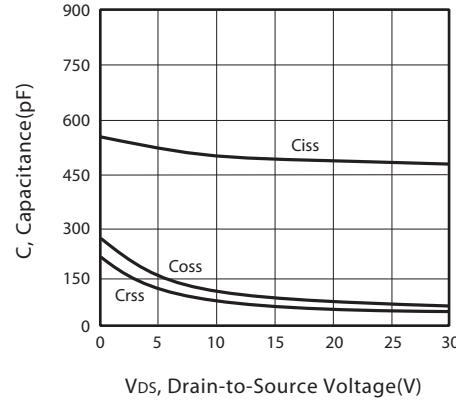
V_{GS}, Gate-to-Source Voltage(V)

Figure 7. On-Resistance vs. Gate-to-Source Voltage



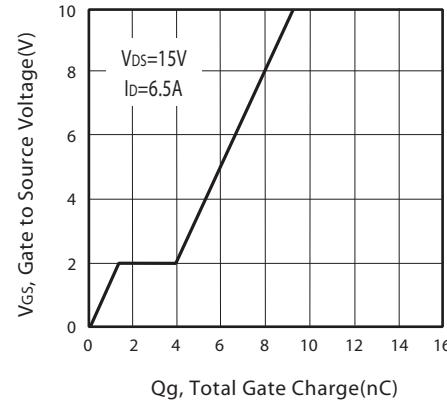
V_{SD}, Body Diode Forward Voltage(V)

Figure 8. Body Diode Forward Voltage Variation with Source Current



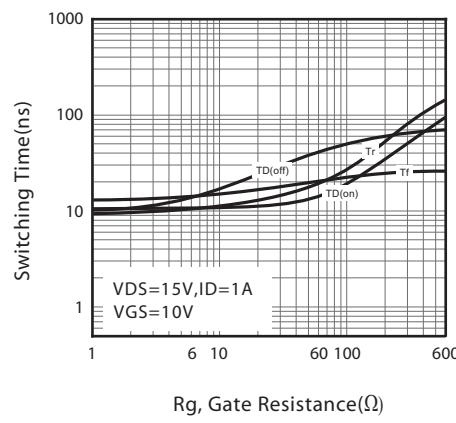
V_{DS}, Drain-to-Source Voltage(V)

Figure 9. Capacitance



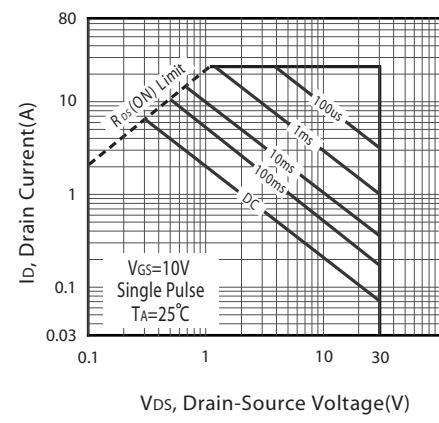
Q_g, Total Gate Charge(nC)

Figure 10. Gate Charge



R_g, Gate Resistance(Ω)

Figure 11. switching characteristics

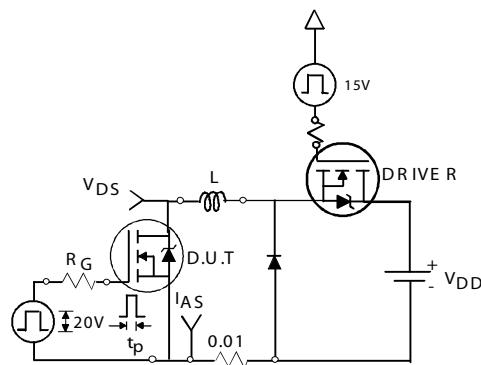


V_{DS}, Drain-Source Voltage(V)

Figure 12. Maximum Safe Operating Area

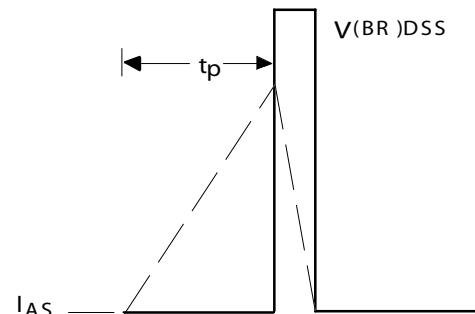
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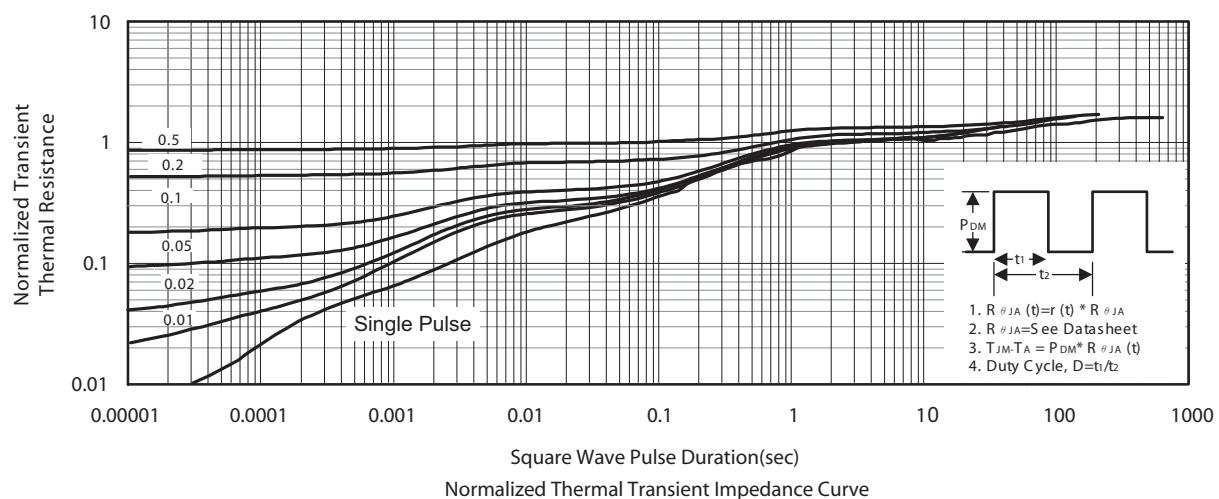
Unclamped Inductive Test Circuit

Figure 13a.



Unclamped Inductive Waveforms

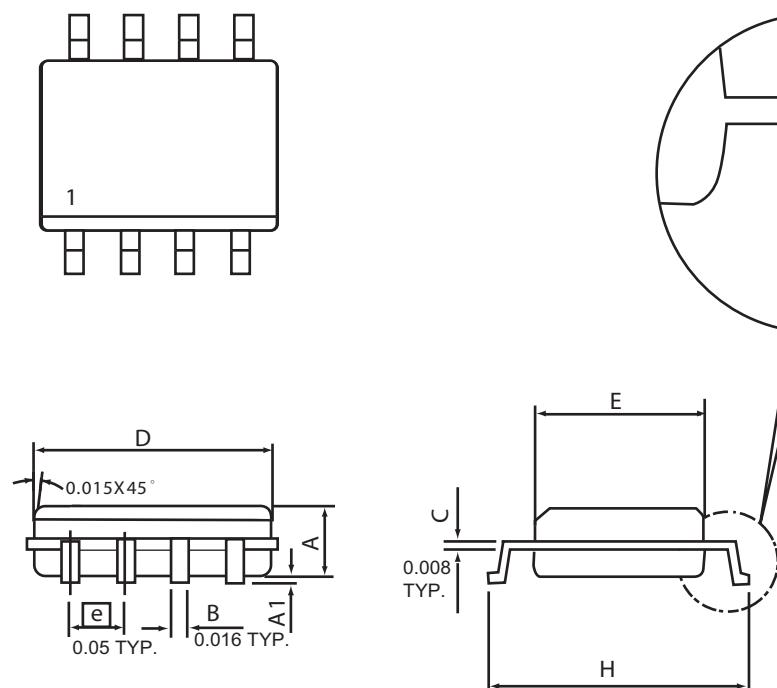
Figure 13b.



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PACKAGE OUTLINE DIMENSIONS

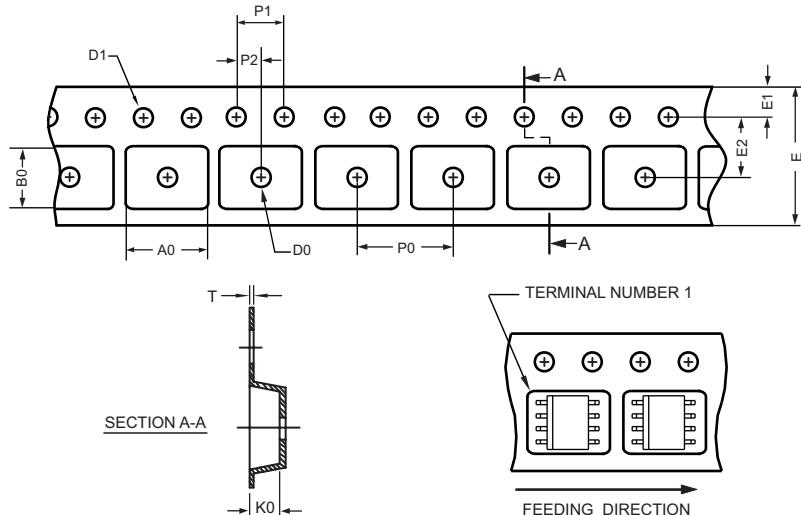
SO-8



SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.35	1.75	0.053	0.069
A1	0.10	0.25	0.004	0.010
D	4.80	4.98	0.189	0.196
E	3.81	3.99	0.150	0.157
H	5.79	6.20	0.228	0.244
L	0.41	1.27	0.016	0.050
θ	0°	8°	0°	8°

SO-8 Tape and Reel Data

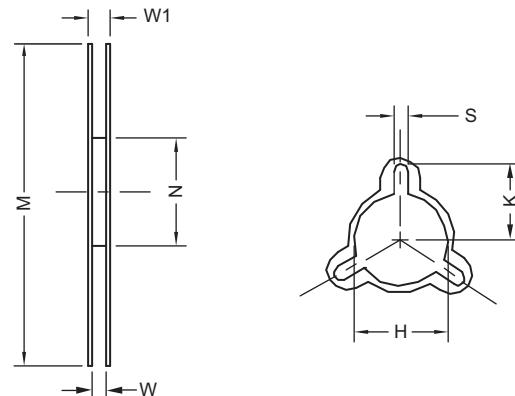
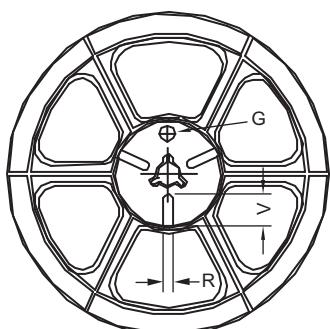
SO-8 Carrier Tape



unit:mm

PACKAGE	A0	B0	K0	D0	D1	E	E1	E2	P0	P1	P2	T
SOP 8N 150mil	6.50 ± 0.15	5.25 ± 0.10	2.10 ± 0.10	$\phi 1.5$ (MIN)	$\phi 1.55$ ± 0.10	12.0 $+0.3$ -0.1	1.75 ± 0.10	5.5 ± 0.10	8.0 ± 0.10	4.0 ± 0.10	2.0 ± 0.10	0.30 ± 0.013

SO-8 Reel



UNIT:mm

TAPE SIZE	REEL SIZE	M	N	W	W1	H	K	S	G	R	V
12 mm	$\phi 330$	330 ± 1	62 ± 1.5	12.4 $+0.2$	16.8 -0.4	$\phi 12.75$ $+0.15$	---	2.0 ± 0.15	---	---	---